

Title (en)

METHOD FOR SEPARATING STRUCTURES FROM A SUBSTRATE

Title (de)

VERFAHREN ZUM TRENNEN VON STRUKTUREN VON EINEM SUBSTRAT

Title (fr)

PROCÉDÉ DE SÉPARATION DE STRUCTURES D'UN SUBSTRAT

Publication

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Application

**EP 21716342 A 20210330**

Priority

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Abstract (en)

[origin: WO2022207083A1] The invention relates to a method and a device for separating structures from a substrate. The invention also relates to a method and a device for transferring structures from a first substrate to a second substrate.

IPC 8 full level

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